GST2035B08EIF

20A TRIAC

Product Description

It is a Triac with V_{RRM} 800V and $I_{T(\text{RMS})}$ 20A.

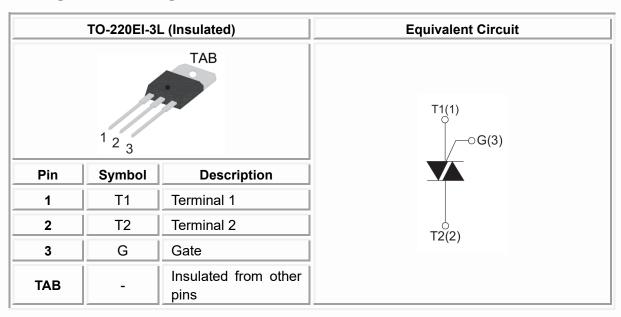
Features

- Glass Passivated Chip Junction
- High Voltage and Surge Capability
- Triggering in Three Quadrants

Mechanical Data

- TO-220EI-3L Package (Insulated)
- RoHS Compliant and Halogen Free

Packages & Pin Assignments





Ordering and Marking Information

Ordering Information				
Part Number Package		Marking	Quantity	Packaging Type
GST2035B08EIF	TO-220EI-3L	T2035-800EI	50 PCS	Tube

GST2035B 1122F

- Product Code: GST2035B
- Voltage Code: 1 1 is 08 for 800 V_{RRM}
- Package Code: 2 2 El for TO-220EI-3L

- Green Level:

 ${\bf F}$ for RoHS Compliant and

Halogen Free

Marking Information

T2035-800EI

- Product Code: T2035-800El - GS Code:



Absolute Maximum Ratings (T_A=25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
V _{DRM}	Repetitive peak off-state voltage (T _J = 25°C)	800	V
V _{RRM}	Repetitive peak reverse voltage (T _J = 25°C)	800	V
I _{T(RMS)}	RMS on-state current (T _C =70°C)	20	Α
Ітѕм	Non repetitive surge peak on-state current (180° conduction angle, f = 50Hz, t _P = 20ms, full cycle)	200	А
l²t	Value for fusing (t _P = 10ms)	200	A ² S
dl/dt	Critical rate of rise of on-state current $(I_G = 2 \times I_{GT}, t_r \le 100 \text{ns})$	100	A/µs
I _{GM}	Peak gate current	4	Α
P _{G(AV)}	Average gate power dissipation	1	W
Rөлс	Thermal Resistance, Junction to Case	1.9	°C/W
TJ	Junction Temperature Range	-40 to +150	°C
Тѕтс	Storage Temperature Range	-40 to +150	°C

Electrical Characteristics (T_A=25°C unless otherwise specified)

Logic Level & Snubberless (3 Quadrants)

Symbol	Test Condition	Quadrant	Min	Max	Unit
I _{GT}	$V_D = 12V, R_L = 100\Omega$	1 - 11 - 111	-	35	mA
V _{GT}	$V_D = 12V, R_L = 100\Omega$	1 - 11 - 111	-	1.3	V
$V_{\sf GD}$	$V_D = V_{DRM}$, $T_J = 125$ °C	1 - 11 — 111	0.2	_	V
	I _G = 1.2×I _{GT}	I - III	-	50	mA
l _L		II		90	
lн	V _{AK} = 12V, I _{GK} = 100mA		-	40	mA
dV/dt	V _D = 67% V _{DRM} , Gate Open	T _J = 125°C	500	-	V/µs
V _{ТМ}	I _{TM} = 28A, t _P = 380µs	T _J = 25°C	-	1.5	V
I _{DRM/RRM}	$V_D = V_{DRM}, V_R = V_{RRM}$	T _J = 25°C	-	5	μΑ
		TJ = 125°C	-	2.5	mA



Typical Performance Characteristics (T_A=25°C unless otherwise specified)

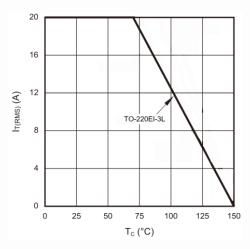


Figure 1. $I_{T(RMS)}$ vs. T_{C}

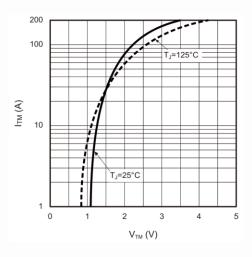


Figure 3. ON State Characteristics

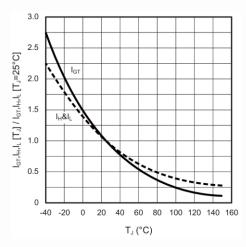


Figure 5. Relative Variations of IG, IH and IL vs. $T_{\rm J}$

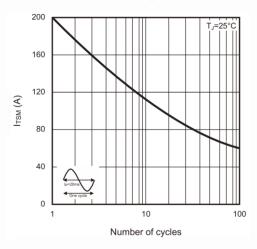


Figure 2. I_{TSM} vs. Number of Cycle

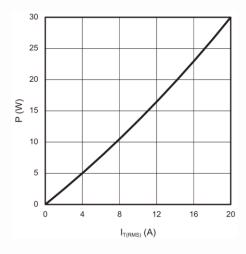
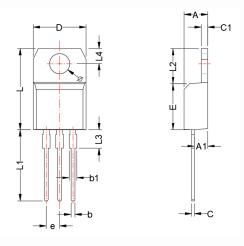


Figure 4. PD vs. IT(RMS)



TO-220EI-3L

Package Dimension



	Dimensions				
Cumahal	Millimeters		Inches		
Symbol	Min	Max	Min	Max	
Α	4.38	4.61	0.172	0.181	
A 1	2.35	2.75	0.093	0.108	
b	0.60	0.92	0.024	0.036	
b1	1.14	1.70	0.045	0.067	
С	0.35	0.70	0.014	0.028	
C1	1.15	1.36	0.045	0.054	
D	9.80	10.40	0.386	0.409	
E	8.60	9.70	0.339	0.382	
е	2.54 BSC		0.100 BSC		
L	14.80	16.10	0.583	0.634	
L1	13.00	14.00	0.512	0.551	
L2	5.85	6.95	0.230	0.274	
L3	2.80	4.20	0.110	0.165	
L4	2.65	3.10	0.104	0.122	
Ø	3.70	3.95	0.146	0.156	

NOTE:

Dimensions are exclusive of Burrs, Mold Flash and Tie Bar extrusions.



NOTICE

- Globaltech Semiconductor assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all Globaltech Semiconductor products described or contained herein. Globaltech Semiconductor products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.
- Applications shown on the herein document are examples of standard use and operation. Customers are
 responsible in comprehending the suitable use in particular applications. Globaltech Semiconductor makes no
 representation or warranty that such applications will be suitable for the specified use without further testing or
 modification.
- The information furnished is believed to be accurate and reliable. However, Globaltech Semiconductor assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties, which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Globaltech Semiconductor. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information without express written approval of Globaltech Semiconductor.

CONTACT US

	GS Headquarter		
\	4F, NO.43-1, Lane 11, Sec. 6, Minquan E. Rd Neihu District, Taipei City 114761, Taiwan (R.O.C).		
<u>Fo</u>	886-2-2657-9980		
	886-2-2657-3630		
@	sales_twn@gs-power.com		

RD Division		
\:\!\!	824 Bolton Drive Milpitas. CA. 95035	
6	1-408-457-0587	

